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A Photothermoelectric Twist to Wireless Energy Transfer: Radial Flexible Thermoelectric Device Powered by a High-Power Laser Beam

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35 Keywords: wireless energy transfer, thermoelectric devices, high-power lasers, screen-
36 printing, space exploration

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41 Wireless energy transfer (WET) systems are becoming increasingly appealing nowadays.
42 Herein, we present a WET system based on the photothermoelectric effect (PTE). With an
43 incident laser beam at $\lambda=1450$ nm, a temperature gradient is generated in the radial flexible
44 thermoelectric (TE) device, with a carbon-based light collector in its center to enhance the
45 photo-heating. The 3-part prototype presents a unique approach by using a radial TE device
46 with one simple manufacturing process – screen-printing. A TE ink with a polymeric matrix of
47 PEDOT:PSS and doped-PVA and Sb-Bi-Te (SBT) microparticles was developed, with $S\sim 33$
48 μVK^{-1} and $\sigma\sim 10.31$ Sm^{-1} , presenting good mechanical and electrical stability. Regarding the
49 device, a full electrical analysis was performed, and the influence of the light collector was
50 studied using thermal tests, spectrophotometer measurements and numerical simulations. A
51 maximum output voltage of ~ 16 mV and a maximum power density of ~ 25 μWm^{-2} were
52 achieved with a $P_{\text{laser}}=2$ W. Moreover, the device viability under extreme conditions was
53 explored. At $T\sim 180$ K, a 25% increase in the output voltage compared to room-temperature
54 conditions was achieved, and at low pressures ($P\sim 10^{-6}$ Torr), an increase of 230% was obtained.
55 Overall, the presented prototype allows the supply of energy at long distances, ideal for sensors
56 in remote places, especially for space exploration.

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69 **1. Introduction**

70 Over the last few decades, our society has been witnessing the fast-growing interconnected
71 environment responsible for the extraordinary volume of data available. Permanent monitoring
72 is only possible due to the intense network of sensors that allows a broad collection of data.
73 Usually, their implementation relies on the use of batteries, thus requiring maintenance and
74 limiting their lifetime.^[1,2]

75 Hybrid photothermoelectric (PTE) devices are an emerging technology with promising
76 potential for a vast range of applications, mainly for those where the conventional energy supply
77 systems fall short. These devices not only use the thermoelectric (TE) effect (direct conversion
78 of a temperature gradient into a voltage), but can also rely on high light absorption and/or
79 plasmonic phenomena, capable of enhancing the overall generated temperature gradient.^[3,4]

80 When that approach is not feasible and higher temperatures are desired, a separated light
81 absorbing system is implemented in a TE generator. That way, the light is focused on the
82 absorber, and the heat is conducted to one of the extremities of the TE part, increasing the
83 temperature of the hot side.^[3,5,6] Since the light collector can be tailored and optimized for a
84 specific wavelength, its efficiency can be higher for that radiation, overlooking the efficiency
85 for the whole spectrum. Some examples of these light collectors include simple high light
86 absorbing materials^[7,8], layered structures^[9,10], dispersions^[5,11,12], superlattices^[6] and
87 metamaterials and metasurfaces^[13–15]. Since some of the studies focus on the implementation
88 of the absorbing materials to the thermoelectric device, their influence is evaluated in
89 commercial thermoelectric generators (TEGs).^[13,15] To achieve higher TE performances,
90 previous studies with PTE devices report different techniques to fabricate the TE generators.
91 Some of them include thin-films by photo-lithography^[7,8,16], nano dispersions^[3,9], and some
92 printing processes such as dispenser printing^[6] and drop-casting^[12,17]. In particular, Wen *et al.*^[5]
93 reports a flexible hybrid photothermoelectric generator composed of a thermoelectric generator
94 and a light-to-thermal conversion layer, with an absorbing and a reflective sides. Although the
95 TEG is produced by screen-printing, the light-to-thermal conversion layer is fabricated by blade
96 coating, making it more difficult to transfer to mass production. Furthermore, the proposed
97 device reached a maximum temperature gradient of 50 K with a simulated sunlight. Due to the
98 linear serpentine design, a large area has to be illuminated, thus decreasing the effective energy
99 to absorb because of the light scattering. In contrast, the radial configuration takes advantage
100 of a small central area where the light can be concentrated in one spot, reducing the illuminated
101 area, increasing the effective absorbed energy for higher temperature gradients. This
102 configuration is more commonly used for cylindrical heat sources, such as conduit pipes^[18] and

103 radioisotopes^[19]. Due to the different light sources, configurations, and operation conditions, a
104 direct comparison between the various devices described in the literature is not yet possible,
105 but the fast evolution of these technologies appear promising.

106 In the improvement of the overall performance of a PTE, the thermoelectric component plays
107 a significant role. Bi-Te alloys are the most conventional materials used to fabricate TE devices
108 due to their excellent performance, especially at low- to room-temperature.^[20–22] Despite their
109 high efficiencies in bulk, the lack of versatility and adaptability are challenges to be
110 overcome.^[23] For this reason, alternative strategies to apply other types of materials to TE
111 devices are emerging. One of those strategies involves organic materials due to their mechanical
112 flexibility, low-cost fabrication, and low weight.^[24–26] For this purpose, the study of several
113 possible organic polymers has increased: conductive polymers^[27], such as poly(3,4- ethylene
114 dioxythiophene):poly(styrene sulfonate) (PEDOT:PSS)^[28–30], polyaniline (PANI)^[31,32], and
115 polypyrrole (PPy)^[33,34], that usually present low thermal conductivity; and insulating polymers,
116 such as polyvinylidene fluoride (PVDF)^[35,36], epoxy resin^[37,38], polylactic acid (PLA)^[39,40],
117 polyvinyl pyrrolidone (PVP)^[41,42] and polyvinyl alcohol (PVA)^[43–45], used as the matrix for
118 inorganic materials, increasing their adhesion.^[46] Consequently, the organic composites of Bi-
119 Te alloys appear as a viable approach to combine the high efficiencies of the TE material with
120 the range of possibilities that the flexibility and low cost of the organic polymers can bring.

121 In particular, Pires *et al.*^[44] and Zhang *et al.*^[45] show that the use of a PVA and a
122 PEDOT:PSS+PVA matrix with Bi₂Te₃ and Bi_{0.5}Sb_{1.5}Te₃, respectively, grants low-cost TE
123 materials with excellent flexibility, with an attractive performance. Likewise, fabricated by
124 screen-printing, the micro-composite of Bi₂Te₃+PVA shows a Power Factor (PF) of 0.4 $\mu\text{WK}^{-1}\text{m}^{-1}$
125 with a Seebeck coefficient of -160 μVK^{-1} ^[44]. Moreover, by using a nano-composite with
126 nanocrystals of Bi_{0.5}Sb_{1.5}Te₃ with a PEDOT:PSS+PVA matrix, the developed self-standing TE
127 film, fabricated by drop-casting, shows a higher PF of 47.7 $\mu\text{WK}^{-1}\text{m}^{-1}$, with an remarkable
128 flexibility.^[45]

129 These Energy Harvesting (EH) systems combined with Wireless Energy Transfer (WET) opens
130 the possibilities of powering devices whilst taking advantage of the prolonged lifetime of these
131 mechanisms due to the conversion of ambient energy, enabling a possible perpetual
132 operation.^[47] Due to the advantages of these hybrid devices, their use in systems for energy
133 supply at remote places becomes appealing. In particular, space exploration is highly dependent
134 on solar and radioisotope energy, thus reliable alternatives or complementary systems are
135 appealing to apply in these extreme conditions (low temperature and low pressure).

136 Overall, WET systems are emerging at a fast rate due to the great necessity to find a solution
137 for the limitations in flexibility, adaptability, convenience and safety that the conventional
138 power transmission operations present. Consequently, numerous WET mechanisms have been
139 developed to replace metal wires/cables in applications where mobility is key.^[48] These
140 mechanisms comprise electromagnetic induction, magnetic resonance, and radiofrequency
141 waves, being categorized into nonradiative or radiative. The nonradiative technologies are
142 based on near-field inductive coupling or magnetic resonant coupling, presenting high
143 efficiencies, though highly dependent on the distance, limiting its usage to short and mid-range
144 distances.^[49] On the other hand, the radiative mechanisms use antennas or other transmitters to
145 propagate the power waves, allowing the coverage of significant distances (several meters to
146 kilometres). The radiation transmission should be directed to the desired location to achieve
147 high efficiencies, thus relying on tracking mechanisms to detect the desired position.^[50]
148 Microwaves and laser beams are well-known forms of electromagnetic radiation used in far-
149 field WET systems.^[51] Although microwaves are less affected by atmospheric attenuation, they
150 tend to present safety concerns due to their large wavelengths, which are difficult to collimate,
151 and expensive production making their miniaturization challenging. Contrarily, laser-beam
152 power allows the use of a collimated light beam with a controlled wavelength and direction,
153 with easy integration and volume production, without detrimental interference to electronic
154 devices. Hence, laser-beam power transmission has become an appealing technology in the
155 WET field, especially when coupled with other systems.^[52] Lately, laser WET is being
156 combined with photovoltaic cells to power devices at long distances, specifically for space
157 exploration.^[53,54] The use of a laser beam over the conventional solar radiation allows the
158 remote illumination of the photovoltaic cells when the solar exposition is insufficient, thus
159 reducing the reliance on energy storage.^[55] Another method to take advantage of the high power
160 of a laser beam, besides the photoelectric effect, is related to the concept of EH, particularly the
161 thermoelectric effect, that could be appealing for the laser beam WET systems because it can
162 convert the heat load caused by the incidence of the light into electrical energy. Usually, two
163 main approaches can be considered, *i.e.*, PTE devices as photodetectors^[13], and PTE generators
164 for low-power consumption sensors.^[7] Due to the low generated thermoelectric voltage, the
165 photodetectors route tends to be more common.^[13,14,56] For this reason, and due to the difficulty
166 in having a uniform temperature gradient in environment scenarios for energy harvesting^[3], the
167 research in PTE devices has been focused in high efficiencies for the sun light spectrum, *i.e.*
168 visible and near infrared radiation.^[5,7,57] However, with the growing development of low-
169 consumption electronics, the generated voltages of a TE generator are becoming more and more

170 appealing.^[58] By reducing the dependence on environment conditions, higher outputs can be
171 achieved. In the case of the PTE effect, a controlled light source can be the key to optimize
172 these devices, thus using sun light is not the most beneficial scenario. Moreover, when using
173 sun light, typically an optical system has to be taken into consideration, *i.e.* a set of lenses to
174 focus the sun rays in the light collector.^[8,16] For example, using a collimated coherent light
175 source with a high brightness and at a specific wavelength, *i.e.*, a laser beam, can reduce the
176 complexity of the optical system, as well as, increase the generated heat. In particular, laser
177 beam emission in the near-infrared region (NIR) ($\lambda \sim 1550$ nm), have been used in deep-space
178 optical communications, due to the low atmospheric absorption of the radiation at this
179 wavelength.^[59]

180 In this work, we present a wireless energy transfer system based on flexible radial
181 photothermoelectric devices, where a light beam is focused in the small centre of the device
182 (collector). A controlled high-power laser beam was used to heat the radial thermoelectric
183 device, being focused on a carbon-based light collector, with high absorption at the used
184 wavelength ($\lambda = 1450$ nm). This is the first radial PTE for WET in the NIR range, manufactured
185 only by screen-printing. The TE ink was developed by combining Sb-Bi-Te (SBT)
186 microparticles with PEDOT:PSS and doped PVA. The performance of the device was evaluated
187 for different pressures and temperatures to study its viability under extreme conditions for
188 remote applications, mainly space exploration.

189

190 **2. Results and discussion**

191 **2.1. Thermoelectric materials and light collector**

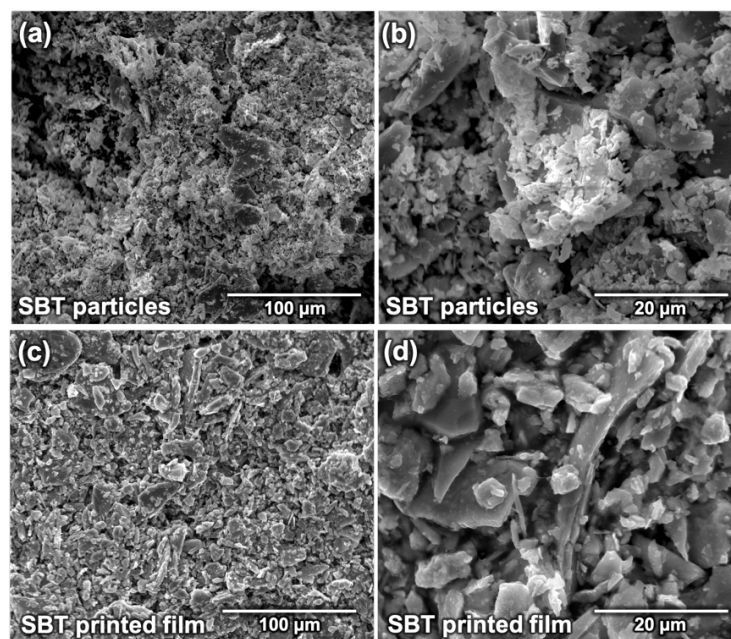
192 *2.1.1. Thermoelectric materials*

193

194 The TE inks developed in this work were obtained by the combination of three different
195 compounds: an inorganic material, a conductive polymer and an insulating polymer, *i.e.* SBT
196 microparticles, PEDOT:PSS and PVA doped with H_3PO_4 , respectively. To have a better
197 understanding of the influence of each component morphologic, structural, and electric
198 transport characterizations were carried out.

199 The SEM micrographs for the SBT microparticles and the SBT printed film are presented in

200 **Figure 1.**

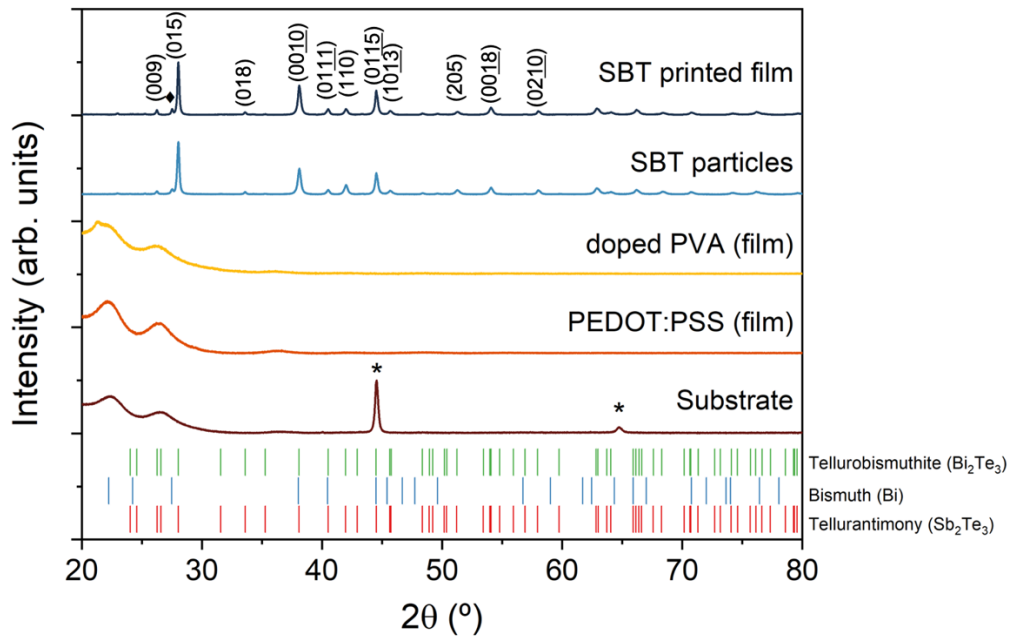


201
 202 **Figure 1** SEM images of a,b. the SBT particles, and c,d. top surface of the SBT printed film,
 203 with a magnification of 1 000× and 5 000×, respectively.

204 The particle size and shape distributions in both samples present a large range, with countless
 205 shapes (see **Figure 1a** and **c**). However, the particles in the printed film appear to be uniformly
 206 distributed in size (see **Figure 1b** and **d**). This aspect comes from the high homogeneity of the
 207 produced ink and the printing process that allows the even spread of the microparticles.
 208 Moreover, the SEM images show the vast distribution of particles along the film, revealing a
 209 high density with lower porosity. This fact can be explained by the affinity between the used
 210 materials, allowing a uniform ink with high printability qualities for screen-printing (see **Figure**
 211 **1c**). The thickness of the sample was determined using the cross-section image (see in **Figure**
 212 **S1** in the Supporting Information), and the value of $53 \pm 3 \mu\text{m}$ was obtained.

213 From EDS analysis, the atomic percentage of Sb, Bi, and Te for SBT particles and TE film was
 214 determined, and it is summarized in **Table S1** in the Supporting Information. The obtained
 215 ternary compound presents a majority atomic percentage of Tellurium (Te) (58.3 at%), followed
 216 by Antimony (Sb) (28.6 at%), and lastly Bismuth (Bi) (12.0 at%). The stoichiometry of the TE
 217 microparticles was determined, thus the resulting powder revealed to be $\text{Sb}_{1.47}\text{Bi}_{0.62}\text{Te}_3$. In the
 218 obtained stoichiometry, a combination of an SBT alloy with excess Bi can be seen, differing
 219 from the typical $\text{Sb}_{2-x}\text{Bi}_x\text{Te}_3$ compositions.^[60–62] Therefore, the studied composite can be
 220 identified as $\text{Sb}_{1.47}\text{Bi}_{0.53}\text{Te}_3 + 1.77 \text{ at\% Bi}$. By comparing the atomic percentage of each element,
 221 both samples show approximately the same values, thus the combination with the polymeric
 222 matrix did not alter the composition of the inorganic particles.

223 X-ray Diffraction (XRD) analysis was carried out for the different involved compounds, as well
 224 as, for the obtained TE film (PEDOT:PSS + doped PVA+ SBT), to inspect the influence of the
 225 organic and inorganic materials in the crystallinity of the final printed film. The Kapton
 226 substrate, chemically treated as described in the experimental section, was also inspected.
 227 **Figure 2** shows the X-ray diffractograms for the different samples (Kapton substrate,
 228 PEDOT:PSS (film), doped PVA (film), SBT particles, and SBT printed film) in a range of 2θ
 229 $= 20^\circ - 80^\circ$.



230
 231 **Figure 2** XRD patterns of the different involved compounds, as well as, the TE film
 232 (PEDOT:PSS + doped PVA + SBT). The position of the main reflections of Tellurobismuthite
 233 (Bi_2Te_3) (JCPDS no. 89-2009), Bismuth (Bi) (JCPDS no. 44-1246), and Tellurantimony
 234 (Sb_2Te_3) (JCPDS no. 71-0393) are presented. The main reflections that are identified and
 235 indexed correspond to the Tellurantimony (Sb_2Te_3), similar to Tellurobismuthite (Bi_2Te_3). The
 236 doped PVA (film) and PEDOT:PSS (film) samples are printed films of the polymers in the
 237 substrate. The highlighted reflections (*) correspond to the main Al reflections due to the
 238 measurement apparatus. The secondary highlighted reflection (♦) correspond to a Bi main
 239 reflection (012), due to the excess of Bi in the SBT particles.

240
 241 Firstly, regarding the organic compounds, the diffractogram of the substrate presents two
 242 crystalline reflections ($2\theta \sim 44.55^\circ$ and $2\theta \sim 64.78^\circ$). These reflections are in concordance with
 243 the XRD pattern of aluminum (Al) (as JCPDS 71-1123) and are present due to the sample holder
 244 of measuring apparatus. Moreover, the diffractograms for the doped PVA and PEDOT:PSS

245 films only have present the substrate contribution. This could be due to the low thickness of the
246 printed films, causing a low signal, thus the amorphous envelope is prevalent.^[63]

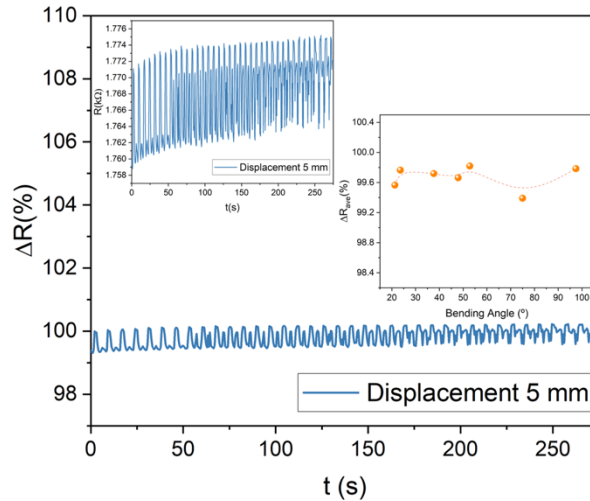
247 Looking at the inorganic materials, the SBT particles present main reflections that correspond
248 to the Tellurantimony (Sb_2Te_3), similar to Tellurobismuthite (Bi_2Te_3) ($R\bar{3}m$ space group),
249 namely, $2\theta = 26.25^\circ$ (0 0 9), $2\theta = 28.03^\circ$ (0 1 5), $2\theta = 33.59^\circ$ (0 1 8), $2\theta = 38.09^\circ$ (1 0 10), $2\theta =$
250 40.52° (0 1 11), $2\theta = 41.98^\circ$ (1 1 0), $2\theta = 44.52^\circ$ (0 1 15), and $2\theta = 45.67^\circ$ (1 0 13). Comparing
251 the lattice parameters, values of $a = 4.290(3) \text{ \AA}$; $c = 30.453(12) \text{ \AA}$ were obtained, corresponding
252 to the JCPDS no. 71-0393 (Sb_2Te_3) ($a = 4.2962 \text{ \AA}$; $c = 30.4847 \text{ \AA}$). The secondary reflection at
253 $2\theta = 27.51^\circ$ (0 1 2) seems to be in agreement with the Bismuth (Bi) pattern. These results match
254 the analysis of SEM/EDS, where an excess Bi was detected. Considering the film's
255 diffractogram, it is evident that the SBT particles are predominant, thus the polymeric matrix
256 does not present any influence in the crystallinity of the printed film, as expected.

257 Regarding the transport properties, both the SBT particles and the TE film were evaluated.

258 The SBT microparticles (p-type) present a Seebeck coefficient of $+168 \mu\text{VK}^{-1}$, and an electrical
259 conductivity of 2379.05 Sm^{-1} , leading to a power factor ($\text{PF} = S^2\sigma$) of $67.15 \mu\text{Wm}^{-1}\text{K}^{-2}$. These
260 results fit the common TE parameters, but for this specific stoichiometry ($\text{Sb}_{1.47}\text{Bi}_{0.53}\text{Te}_3$), both
261 the electrical conductivity and the Seebeck coefficient present lower values than the ones
262 reported in literature ($\sigma \sim 6000 \text{ Sm}^{-1}$; $S \sim 220 \mu\text{VK}^{-1}$ ^[64,65]). The drastic change of the σ value
263 arises from the presence of the excess Bi that increases the Bi_{Te} antisite defects, *i.e.*, the number
264 of charge carriers is reduced, thus decreasing the electrical conductivity.^[66] Another, and
265 probably the main, contributing factor for the low value of σ is the low charge mobility in the
266 boundaries of the particles in the pellet produced for the measurement. Due to the irregular
267 shapes of the particles, electron scattering between the boundaries may occur, creating points
268 of high resistance, reducing the overall electrical conductivity of the sample.^[44]

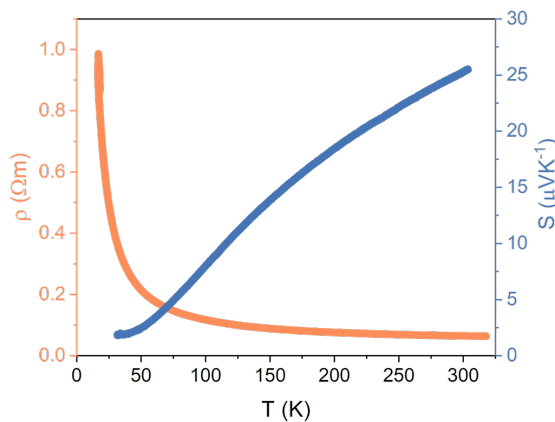
269 Concerning the TE film, after the mixture with the polymeric matrix (SBT + PEDOT:PSS +
270 doped PVA), a decrease in these properties was observed, *i.e.*, $S \sim 33 \mu\text{VK}^{-1}$ and $\sigma \sim 10.31 \text{ Sm}^{-1}$,
271 with corresponding PF of $7.97 \text{ nWm}^{-1}\text{K}^{-2}$. The reduced Seebeck coefficient comes from the
272 relatively high concentration of PEDOT:PSS with low S ($S \sim 13.13 \mu\text{VK}^{-1}$)^[67], causing a small
273 percolation through the polymer and not the TE particles. Moreover, bending tests were
274 performed to analyze the mechanical performance of the printed film (see **Figure 3**). The results
275 show that with consecutive bending cycles (around 50 cycles) over 275 s, the resistance of the
276 printed film did not present considerable variations, being less than 1%, and maintaining the
277 initial R after the test. Furthermore, the resistance was evaluated for different displacements,
278 thus different bending angles, and slight variations were observed ($\sim 0.6\%$). Through these tests,

279 the Young's Modulus of the printed film on the Kapton substrate was obtained, with a value of
 280 0.64 GPa (see **Figure S2** in Supporting Information). These tests reveal the high mechanical
 281 integrity of the printed film, in which its flexibility will not drastically affect the performance
 282 of the material.



283
 284 **Figure 3** Bending test results, in particular the variation of R (ΔR (%)) during the measurement
 285 over 275 s, with a displacement of 5 mm. In inset on the left, the absolute value of R is presented
 286 over time during the test. In inset on the right, the average resistance variation (ΔR_{ave} (%)) is
 287 shown as a function of the bending angle, obtained for different displacement values.

288
 289 To study the TE performance under extreme conditions (low temperature), the evaluation of
 290 the temperature dependence (20 K – 325 K) of S and σ of the TE film was carried out following
 291 Ferreira-Teixeira *et al.* procedure^[68]. The results are shown in **Figure 4**.



292
 293 **Figure 4** Electrical resistivity (ρ) and Seebeck coefficient (S) of the fabricated TE film as
 294 functions of the temperature.

295

296 The obtained behavior for the Seebeck coefficient is consistent with the one expected for an
297 organic semiconductor.^[69] This is caused by the excessive influence of the PEDOT:PSS causing
298 the percolation, as previously mentioned. The electrical resistivity displays a semiconductor-
299 like behavior, reaching a stable value of $\sim 0.14 \Omega\text{m}$ after 150 K, that correspond to the electrical
300 conductivity value measured at room temperature ($\sigma \sim 10.31 \text{ Sm}^{-1}$).

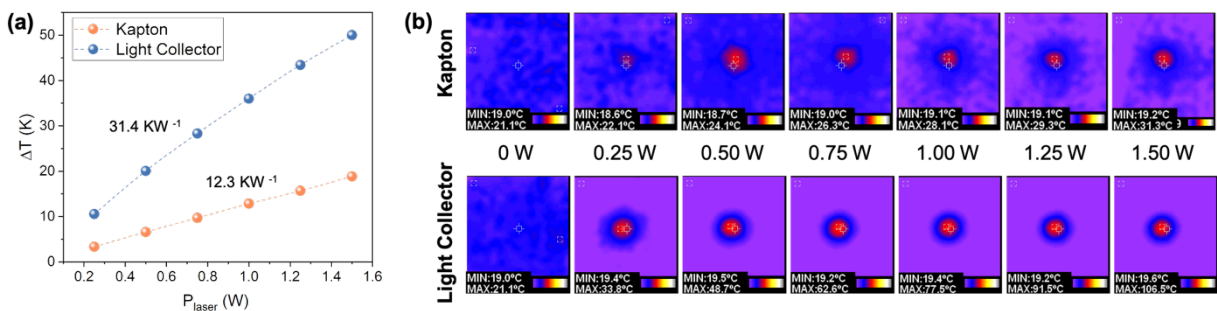
301 Despite presenting lower thermoelectric performance, the developed TE film exhibits good
302 adhesion to the substrate, with high electrical and mechanical stability. For these reasons, the
303 radial flexible TE device was fabricated with this developed ink.

304

305 2.1.2. Light absorption materials

306

307 To increase the obtained temperature gradient (ΔT) in the TE device, a light absorber material
308 was analyzed, *i.e.*, a commercial carbon-based ink. Hence, a thick film of the carbon-based ink
309 (5 cm x 5 cm) was fabricated by screen-printing in a Kapton substrate, with a thickness of
310 around 22 μm . A comparative thermal analysis between the Kapton substrate (thickness ~ 75
311 μm) and the collector film was performed under a continuous-wave (CW) laser beam with a
312 wavelength of 1450 nm in a range of powers from 0 to 1.5 W. In **Figure 5a**, the ΔT values
313 determined for Kapton and the carbon thick film are presented. These values were obtained by
314 directly measuring the temperature at 3 mm and 7 mm from the focusing point with two
315 thermocouples, thus assessing the temperature gradient across the length of a TE stripe in the
316 device.



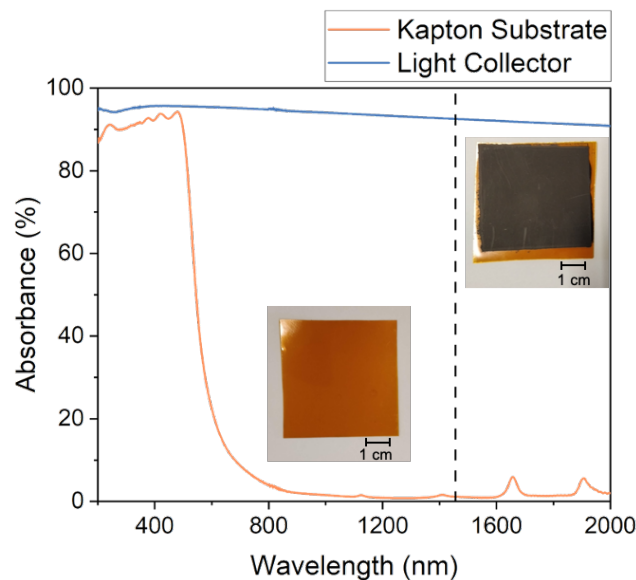
317

318 **Figure 5** a. Temperature gradient values obtained by measuring the laser heating with
319 thermopowers placed at 3 mm and 10 mm from the focusing point. b. Representative thermal
320 images with an incident laser beam in Kapton and Kapton with the printed light collector, for
321 different values of the laser power values (0 - 1.5 W). The images were captured using
322 Welight® Thermal Pro Infrared camera.

323

324 A direct linearity between the laser power and the temperature gradient is verified in both
325 samples, with different rates. The Kapton substrate presents a heating rate of 12.34 KW^{-1} , whilst
326 the collector film has a rate of 31.4 KW^{-1} , more than double the substrate. Hence, a ΔT of ~ 25
327 K and ~ 62 K are expected for a laser power of 2 W, for the Kapton substrate and the collector
328 film, respectively. **Figure 5b** shows the representative thermal images obtained during the tests.
329 These images display the uniform radial heating of the two studied samples. With the light
330 collector, higher temperatures are detected at a given laser power, when compared with the
331 Kapton substrate.

332 To compare the optical response of the substrate and the light collector, the absorbance of each
333 material was measured for a range of wavelengths from 200 nm to 2000 nm. From the results
334 (see **Figure 6**), the absorbance of Kapton for low wavelengths (< 500 nm) is almost as high as
335 the value for the light collector. Above 500 nm, the absorption decreases drastically, since
336 Kapton is semi-transparent to visible radiation. On the contrary, the light collector film presents
337 a nearly constant absorbance across the whole spectrum, being an opaque material. For our
338 working wavelength (1450 nm; traced line in **Figure 6**), it is evident that the light collector film
339 presents a higher absorption than the substrate, thus a higher temperature can be generated with
340 the incidence of a laser beam with that wavelength.



341

342 **Figure 6** Absorbance of the 75 μm -thick Kapton substrate and the light collector thick film, for
343 a wavelength range from 200 to 2000 nm. The traced line is the 1450 nm wavelength, i.e., the
344 wavelength of the used laser beam. In inset, photos of the two measured samples are presented.

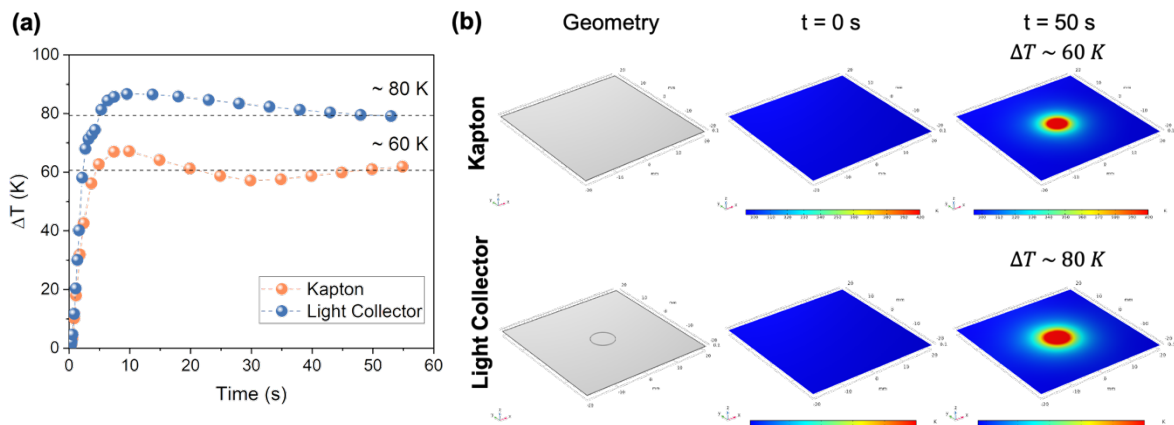
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346 *2.1.3. Numerical Simulations*

347

348 To further verify the different generated ΔT by an incident laser beam in the two considered
349 materials, numerical simulations were carried out using the finite element method on COMSOL
350 Multiphysics. In Supporting Information, the main parameters used in the simulation are
351 presented in detail in **Table S2**. The simulated laser beam has the characteristics of the one used
352 in this study. The properties of the Kapton substrate were used from the native COMSOL
353 database. Because the properties of the carbon-based ink were not all well-known, an estimative
354 with the shooting method was used, namely for the heat capacity (C_p), density (ρ), electrical
355 permittivity ($\epsilon = \epsilon' + i\epsilon''$). The obtained values of C_p and ρ , $1470 \text{ JKg}^{-1}\text{K}^{-1}$ and 1190 Kgm^{-3} ,
356 respectively, are in the same order of magnitude of the ones reported for carbon materials (C_p
357 $= 720 \text{ JKg}^{-1}\text{K}^{-1}$ [70]; $\rho = 1700 \text{ Kgm}^{-3}$ [71]). The slight discrepancies can be attributed to the
358 polymeric matrix and solvents present in the commercial ink, besides the carbon material.

359 In **Figure 7a**, the simulated temperature gradients for the substrate and the light collector, with
360 a 2 W CW gaussian laser beam, are presented. Maximum values of $\Delta T \sim 60 \text{ K}$ and $\Delta T \sim 80 \text{ K}$
361 were obtained for the substrate and the light collector, respectively. The determined values are
362 higher than the one obtained experimentally, *i.e.*, $\Delta T_{\text{Kapton}} \sim 25 \text{ K}$ and $\Delta T_{\text{Light Collector}} \sim 62 \text{ K}$. The
363 optimum conditions of the simulation and the small deviations of the estimated parameters can
364 explain the slight discrepancies of these values in relation to the experimental data. However,
365 due to the significant difference between the temperatures for the two materials, the results can
366 still demonstrate the viability of the generation of a temperature gradient by an incident laser
367 beam, with an enhancement when a light collector is used. Furthermore, the temperature
368 distribution on the simulated structure appears radial and uniform, thus in concordance with the
369 expected behavior, and advantageous for the chosen device design (see **Figure 7b**). Moreover,
370 when using the light collector, the heated area in the center increases for higher temperatures,
371 thus increasing the generated gradient.



372

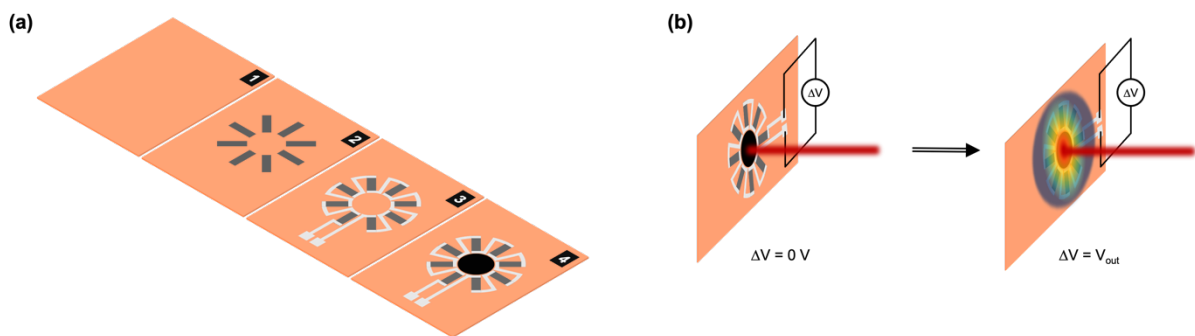
373 **Figure 7** a) Simulated temperature gradients for the Kapton substrate and the light collector,
 374 with an incident gaussian laser beam of 2 W. The ΔT is calculated from the temperatures
 375 determined at 3.7 mm and 10.5 mm from the center, corresponding to the length of a TE stripe
 376 in the developed device. b) Geometry and temperature distributions at $t = 0$ s and $t = 50$ s, for
 377 the Kapton substrate and the light collector (circle with radius = 3.5 mm), in a Kapton substrate.
 378

379 2.2. Hybrid photothermoelectric device

380

381 Considering the aforementioned results, two radial flexible devices were produced with the
 382 presented TE ink, one with and another one without the light collector in the center to inspect
 383 its influence in the final performance of the PTE. The developed device comprises of 3
 384 independent components (electric contacts, TE stripes, light collector), manufactured only by
 385 screen-printing (see **Figure 8a**). The chosen configuration allows the incidence of a laser beam
 386 in the center of the device, creating a temperature gradient from the inside to the outside (see
 387 **Figure 8b**). The devices are composed of 8 thermoelectric stripes, being a single mode device,
 388 *i.e.*, with only a p-type TE material.
 389

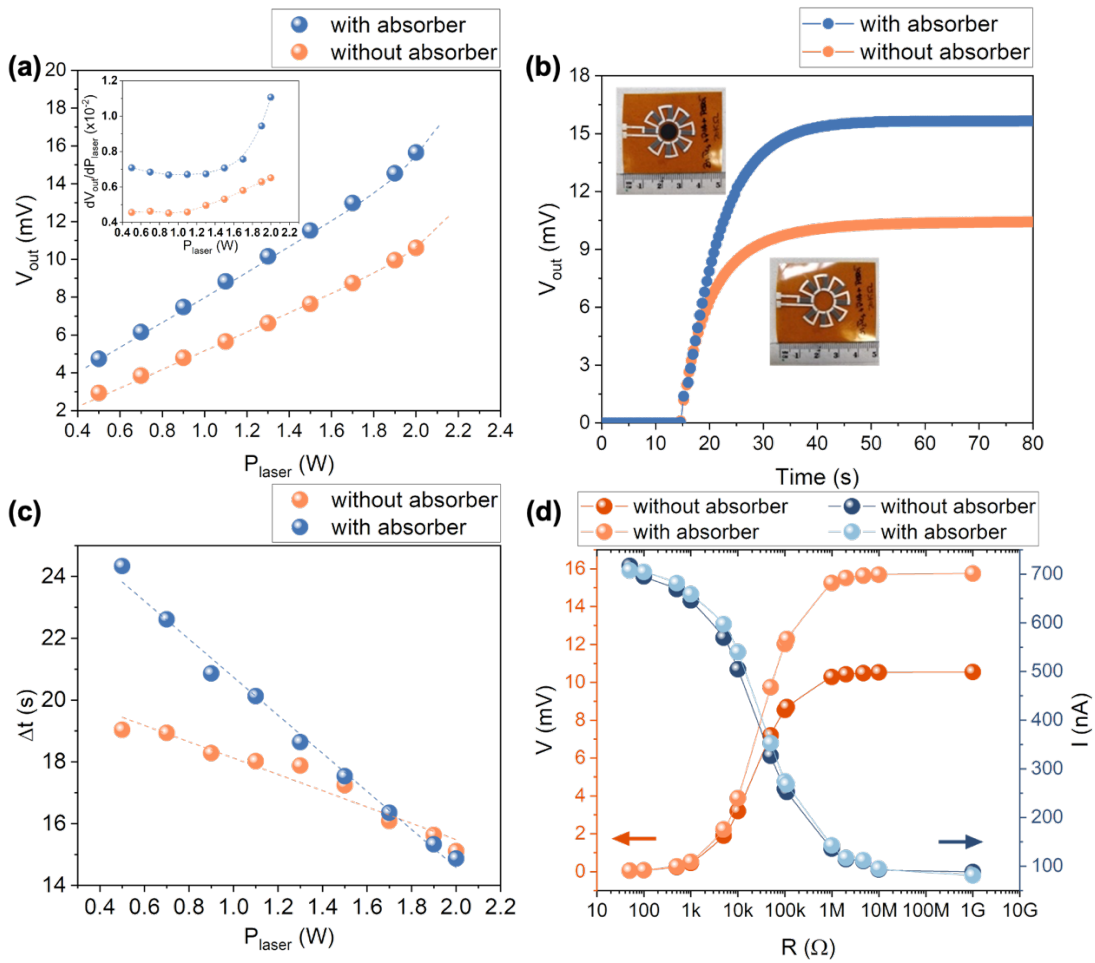
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392 **Figure 8** (a) Fabrication process by screen-printing of the photothermoelectric device: 1.
 393 Kapton substrate; 2. TE stripes; 3. Silver electric contacts; 4. Light collector made of carbon-
 394 based commercial ink. (b) Operation principle of the photothermoelectric device, where a laser
 395 beam is focused on the center of the device, creating a temperature gradient from the inside to
 396 the outside, generating a voltage between the terminals of the radial device.

397



398

399 **Figure 9** a) Device output voltage as a function of the laser power. Inset shows the first
 400 derivative of V_{out} , highlighting its nonlinearity. b) Response when the laser is turned on
 401 ($P_{laser}=2$ W), for the devices without and with the light collector. c) Response times of the
 402 devices without and with the light collector, for different laser powers. d) Voltage and current
 403 generated by the two devices (without and with the light collector), as functions of probe
 404 resistance ($P_{laser}=2$ W). Dashed lines are guides to the eyes.

405 The results of the device performance with a $\lambda = 1450$ nm and different laser powers, ranging
 406 from 0.5 W to 2 W (power density of 1.3 Wcm⁻² and 2.6 Wcm⁻², respectively), and also for the
 407 specific case of $P = 2$ W, are summarized **Figure 9**.

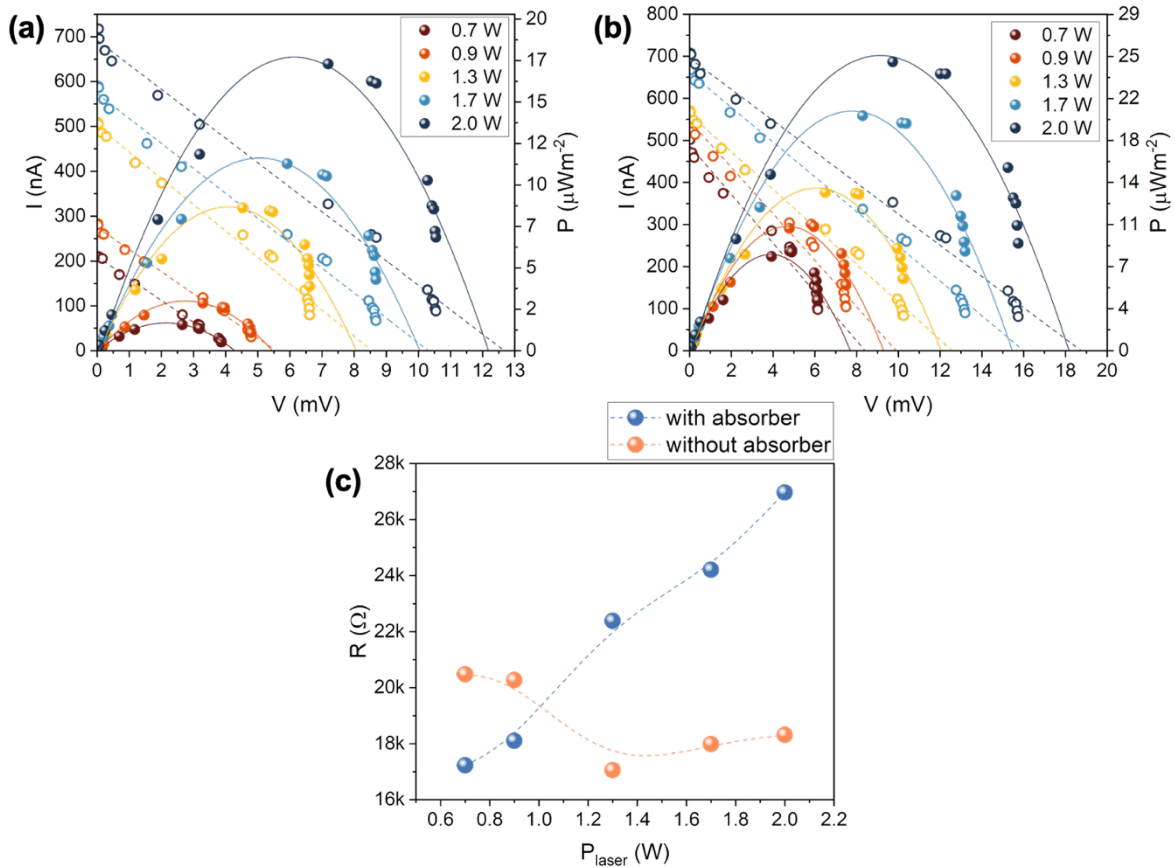
408 Firstly, the open-circuit voltage (V_{out}) was measured for various applied laser powers (P_{laser}), as
 409 showed in **Figure 9a**. An apparent linear correlation can be observed, although looking at the
 410 first derivative (see inset in **Figure 9a**), an exponential increase is present for a threshold P_{laser} ,
 411 that depends on the presence of the light collector. For this reason, this threshold is thought to
 412 be related to the flux of heat from the light absorption, leading to a non-linear temperature
 413 increase for P_{laser} higher than 1.1 W and 1.3 W without and with the light collector, respectively.
 414 The maximum achieved output voltages were ~ 11 mV and ~ 16 mV, without and with the light

415 collector, respectively. Moreover, it was observed that this output is maintained for 3 days with
416 continuous illumination, with variations lower than 5 %. When compared with a similar radial
417 device reported by Zhu *et al.*^[7], the maximum output voltages appear lower, considering 8 TE
418 stripes and a temperature gradient of 60 K ($V_{\text{out}} \sim 66$ mV). By choosing a TE ink with
419 mechanical and electrical stability, the thermoelectric properties are inferior to the ones
420 reported in a study with a similar composition ^[45]. Hence, if we consider their optimized
421 Seebeck coefficient ($S \sim 144 \mu\text{V K}^{-1}$), we can predict that the maximum output voltage that our
422 device can reach would be ~ 69 mV, higher than the previously reported.

423 Besides the higher output, the response time is also influenced by the presence of the collector.
424 As it can be seen in **Figure 9b**, when the laser is turned on, the device rapidly responds and
425 reaches a stable V_{out} value. This response time decreases linearly with the increase of P_{laser} and
426 tends to higher values with the implementation of the collector, particularly for lower powers
427 of the laser (see **Figure 9c**). This can be explained by the different thermal conductivities of the
428 collector and the substrate, causing different heat diffusions. Moreover, the developed device
429 presents a low response time when compared with previous studies ($\Delta t < 30$ s)^[7-9]. Secondly,
430 through the characterization with a load resistance, the behaviors of voltage and current
431 generated by the device were evaluated, as functions of that resistance (see **Figure 9d**). The
432 results show that the presence of the light collector causes an increased voltage, as previously
433 seen, but the generated current remains practically the same.

434 The maximum electrical current achieved was ~ 700 nA, a relatively low value due to the high
435 electrical resistance of the device. By considering the determined electrical conductivity of the
436 TE ink, the electrical resistance (R) of the device was calculated taking into account the shape
437 factor and the series connected stripes, presenting a $R_{\text{calculated}} \sim 5$ k Ω . Contrarily, the measured
438 internal electrical resistance ($R_{\text{int}} \sim 19$ k Ω) shows a great discrepancy with the calculated value,
439 caused by the high electrical resistance between the interfaces of the TE stripes with the
440 electrical contacts, calculated to be $\sim 875 \Omega$ per interface.

441 Regarding the full electrical characterization, the devices seem to follow the predicted behavior,
442 with a linear dependence between the current (I) and voltage (V), by the Ohm's law ($I = RV$),
443 and a second-degree polynomial dependence of the power (P) with the voltage ($P = IV = V^2R$)
444 (see **Figure 10**)^[72].

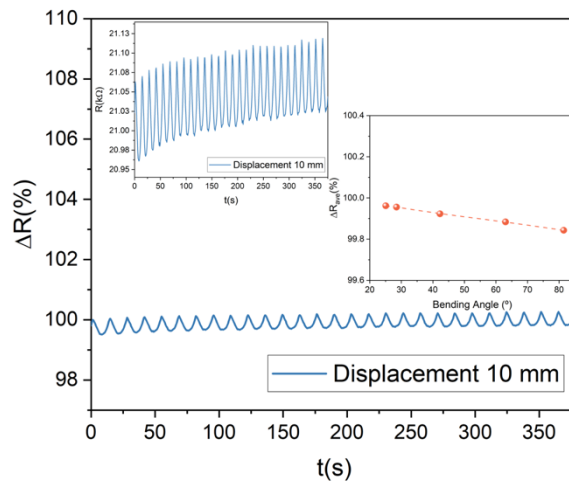


445
 446 **Figure 10** Full electrical characterization of the radial devices, i.e., generated voltage, current
 447 and power density, for different laser powers: a) without and b) with the light collector. c)
 448 Internal resistance determined by Ohm's Law ($I=RV$) for each laser power, without and with
 449 the light collector. Dashed and solid lines are visual cues.

450
 451 As expected, the value of the output voltage increases with power of the incident laser, due to
 452 the increase of ΔT , for both cases. However, the values of current do not follow the same
 453 behaviour with the use of the light collector, as it can be seen by the maximum obtained values
 454 of I in **Figure 10b**. Taking into account Ohm's Law ($I=RV$), the changes in the current values
 455 arise from changes in the internal resistance (R_{int}) of the device, where an almost linear increase
 456 with the increase of P_{laser} can be seen for the device with the light collector, whereas the device
 457 without it has small variations (see **Figure 10c**). This can be explained by the high temperatures
 458 achieved at the extremities of the TE stripes (~ 400 K), at which the electrical conductivity of
 459 the TE material decreases in comparison to the value at room temperature, thus the R_{int} of the
 460 device increases.^[73]

461 The maximum outputs were achieved by using a laser power of 2 W, but since a saturation is
 462 not observed, higher values are expected for even higher powers. The maximum generated

463 power densities obtained are $\sim 17 \mu\text{Wm}^{-2}$ and $\sim 25 \mu\text{Wm}^{-2}$, without and with the light collector,
 464 respectively. As previously mentioned, the low power densities are due to the low
 465 thermoelectric efficiency of the TE ink. However, the improvement with the light collector is
 466 significant, *i.e.*, P_{max} increases almost by 50%. By using the value of the Seebeck coefficient of
 467 the TE ink ($\sim 33 \mu\text{VK}^{-1}$), the created temperature gradient (ΔT) was calculated. Thus, for a laser
 468 power of 2 W, it was possible to achieve $\Delta T_{\text{max}} \sim 40 \text{ K}$ and $\Delta T_{\text{max}} \sim 60 \text{ K}$, for the devices
 469 without and with the light collector, respectively. These values are in concordance with the ones
 470 obtained in the comparative thermal analysis of the substrate and the collector film.
 471 Furthermore, bending tests were performed to the developed device to evaluate the effect of
 472 mechanical strain on the internal resistance of the device (see **Figure 11**). Similar to the results
 473 from the printed film, the variations of R_{int} presented values lower than 1% over more than 30
 474 bending cycles, with a displacement of 10 nm. Moreover, for different bending angles, the
 475 average ΔR decreased linearly with the increasing bending angle, although the all the obtained
 476 values were lower than 0.2%. Hence, the device presents a similar mechanical response as the
 477 printed film, thus a mechanical strain will not compromise the performance of the device.



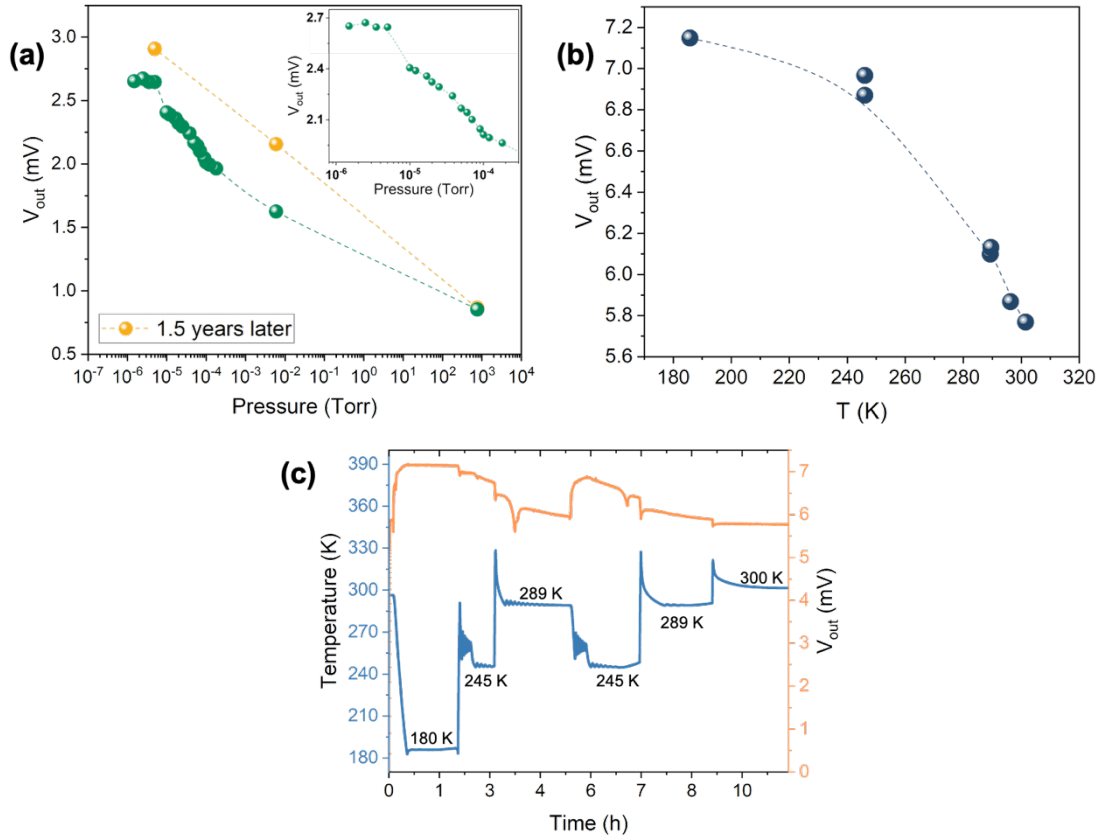
478
 479 **Figure 11** Bending test results, in particular the variation of R (ΔR (%)) during the
 480 measurement over 375 s, with a displacement of 10 mm. In inset on the left, the absolute value
 481 of R is presented over time during the test. In inset on the right, the average resistance variation
 482 (ΔR_{ave} (%)) is shown as a function of the bending angle, obtained for different displacement
 483 values.

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488 **2.3. Output under Extreme Conditions**

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490 Due to the specificity of the aerospace application of the developed device, mainly the CubeSat
491 industry, the evaluation of the prototype performance under extreme conditions is essential.
492 Therefore, the output voltage of the printed device was analyzed for a wide range of pressures
493 ($10^{-6} - 10^3$ Torr) and temperatures (180 – 300 K) (see **Figure 12**).



494

495 **Figure 12** a) Output voltage as a function of the pressure inside the cryostat, and the results 1.5
496 years later. The inset shows the increase and later stabilization for lower pressures in higher
497 vacuum. b) Output voltage of the radial TE device as a function of the temperature inside the
498 chamber. c) Output voltage of the radial TE device and the controlled temperature measurement
499 inside the chamber over a period of almost 12 h.

500

501 Both tests were performed with an incident laser beam power of 0.5 W. Looking into the
502 influence of pressure on the efficiency of the prototype at room temperature, V_{out} generally
503 increases with lower pressures, tending to stabilize for pressures lower than 10^{-5} Torr, as it can
504 be seen in the inset graph in **Figure 12a**. The increase of the output voltage with lower pressures
505 can be explained by two thermal phenomena, *i.e.*, the reduction of heat loss to the environment

506 and the enhancement of thermal contact. Regarding the first phenomenon, due to the lack of a
507 propagation medium under vacuum, the heat loss through conduction and convection can be
508 considered negligible, thus the reduced heat losses are only due to radiation.^[74,75] As for the
509 second phenomenon, the thermal contact of the overall system is seemingly enhanced by the
510 reduction of air pockets present in the various interfaces (TE stripe – electrical contact; TE
511 stripe – substrate; light collector – substrate), formed in the printing process.^[76] Consequently,
512 for lower pressures, the higher temperature gradient can be established, thus increasing the
513 output voltage. Moreover, the results of the measurements performed 1.5 years later, reveal the
514 reproducibility of the system, showing essentially the same variation and absolute values.
515 Regarding the temperature tests ($P \sim 10^{-6}$ Torr), the performance is enhanced for lower
516 temperatures, expected due to the increase of the higher temperature gradient (see **Figure 12b**).
517 However, for lower temperatures, this enhancement does not occur linearly with the
518 temperature, which can be explained by the decreased temperature of the “hot side” that is not
519 significant for higher temperatures. The low-temperature study was carried out during a period
520 of almost 12h, taking into consideration the typical temperature changes that a CubeSat
521 undergoes (245 – 289K)^[77] (see **Figure 12c**). Besides the fact that the output of the device
522 appears to be stable over time, it also presents a rapid response to the variations of the ambient
523 temperature, which is therefore beneficial for those kinds of conditions. Overall, for low
524 temperatures and low pressures, the output voltage increases by 25% and 230%, respectively.

525

526 **3. Conclusions**

527 In this work, a low-cost and flexible device based on the photothermoelectric effect was
528 developed, appearing as a good candidate for long-distance wireless energy transfer and energy
529 on demand at remote places, particularly for space exploration. The proposed prototype is
530 composed of three independent parts (electric contacts, TE stripes, carbon-based light collector),
531 all printed by screen-printing, for easy mass-production. The developed radial device can
532 convert the light of an incident CW laser beam in its center into a temperature gradient, from
533 the inside to the outside. The combination of a polymeric matrix (PEDOT:PSS + doped PVA)
534 with inorganic microparticles ($\text{Sb}_{1.47}\text{Bi}_{0.53}\text{Te}_3 + 1.77$ atom % Bi) guaranteed flexible TE stripes,
535 with mechanical properties and good thermoelectric conversion. With a laser beam at $\lambda = 1450$
536 nm and $P = 2$ W incident on the 8-stripe radial device, a maximum temperature gradient of \sim
537 60 K was achieved, leading to an output voltage of 16 mV and a maximum power density of
538 $25 \mu\text{Wm}^{-2}$. The enhancement caused by the light collector was proven not only by the device’s
539 output, but also by thermal analysis directly in the material, and numerical simulations, showing

540 more than 30% of increase on the generated temperature gradient. Moreover, the viability of
541 the proposed system at extreme conditions was verified, with an increase on the output voltage
542 of 25% for low temperatures ($T \sim 180$ K) and 230% for low pressures ($P \sim 10^{-6}$ Torr). In
543 summary, the developed simple and low-cost radial flexible photothermoelectric device shows
544 a great potential for the transfer of energy for low-power consumption electronics at remote
545 places, regardless of environment conditions.

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549 **4. Experimental Section**

550 *TE powder preparation:* Commercial SBT modules were used to produce the p-type
551 thermoelectric powder. The modules were grinded with a mortar and pestle, to be reduced to
552 powder. Then, a milling process was performed to homogenize of the particles' size, using a
553 Retsch® planetary ball mill PM 100 with 250 rpm. In this system, 30 zirconia beads (1 cm of
554 diameter) are the grinding media in a zirconia ball milling jar, where the particles were placed
555 in a beads-to-powder mass ratio of 10:1, in an isopropanol medium. The milling process was
556 was carried out in a 2-part process, i.e., 30 min of milling, followed 30 min of rest to prevent
557 oxidation, repeated 3 times. The resulting powder was then sieved to obtain particles with
558 dimensions lower than 50 μm .

559

560 *Ink formulation and preparation:* Two different polymers were used to for the polymeric matrix
561 of the flexible thermoelectric ink, i.e., a non-conductive and a conductive. The non-conductive
562 organic-polymer was produced using Polyvinyl alcohol - PVA (purchased from Sigma-Aldrich)
563 doped with orthophosphoric acid - H_3PO_4 (85% analytical grade, purchased from Fisher
564 Chemical) in 1:1 weight ratio. After the solubilization, the mixture of PVA- H_3PO_4 was
565 incubated at 90 °C in a hot plate for 12 h, under continuous stirring, as reported by Pires and
566 co-authors.^[44] The conductive polymer Poly(3,4-ethylenedioxythiophene)-
567 poly(styrenesulfonate) - PEDOT:PSS, was purchased from H. C. Stark, Inc (Clevios™) and
568 used after a continuous stirring, at 2000 rpm for 1h to ensure higher electrical conductivity. The
569 PVA- H_3PO_4 , the PEDOT:PSS, and the SBT powder were mixed until homogeneous, to
570 formulate the thermoelectric ink, with a weight concentration of 16, 16, and 67 wt%,
571 respectively. The obtained thermoelectric ink was used to print a screen pattern with 2×1.5
572 cm, and then dried at 130°C for 10 min to obtain the flexible thermoelectric printed film. PI foil
573 (DuPont, USA, thickness of 75 μm) was used as substrate, previously chemically treated with

574 10 wt% of KOH (for 60 min), 10 wt% of HCl aqueous solution (for 5 min) under continuous
575 stirring, and then washed with Millipore water.^[78] Additionally, commercial carbon-based ink,
576 purchased from Elantas (Bectron® GP 9553VP), was used without further purification to print
577 the light collector. The carbon-based ink thick film was printed in a pre-treated PI substrate
578 using a screen pattern with 5 × 5 cm and then dried at 130°C for 10 min. Commercial silver ink
579 was purchased from VFP Ink Technologies and used as bought for the electrical contacts.

580

581 *Characterization of TE/collector materials:* The printed thermoelectric ink was characterized
582 using a Scanning Electron Microscope (SEM), a Phillips-FEI/Quanta 400 FEG from the
583 Materials Center of the University of Porto (CEMUP), with coupled X-ray Energy Dispersive
584 Spectroscopy (EDS). The X-ray diffraction (XRD) measurements, in a Bragg-Brentano
585 configuration, were performed on a SmartLab Rigaku diffractometer, at room temperature, with
586 Cu K α radiation ($\lambda = 1.5406 \text{ \AA}$, with a 200 mA, 45 kV), from $2\theta = 10^\circ$ to 100° . Regarding the
587 transport properties, the room-temperature Seebeck coefficient was measured using an in-plane
588 homemade setup composed of two independent Cu support pillars already reported in Pires *et*
589 *al.*^[44]. The room-temperature electrical conductivity of the printed thermoelectric film was
590 measured using the four-point method where a 2410-C SourceMeter® from Keithley
591 Instruments Inc. was used. The evaluation of the temperature dependence (20 K – 325 K) of S
592 and σ of the TE film was carried out following Ferreira-Teixeira *et al.*^[68] procedure.

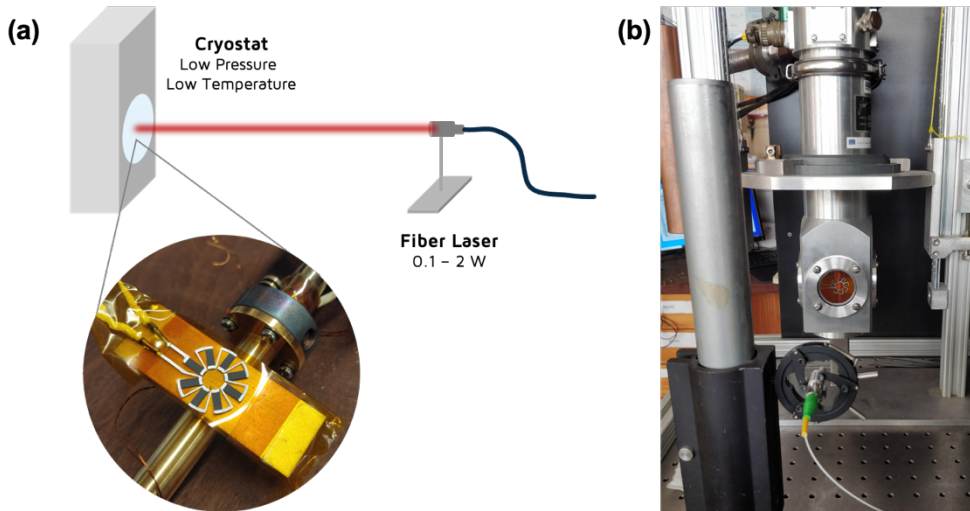
593 Regarding the light collector, a UV-Vis-NIR Systems (Agilent Cary Spectrophotometer) was
594 used to determine the absorption percentages with a scan rate of 600 nm/min, and a slit width
595 of 2 nm. The 5 x 5 cm thick film was used to analyze the flexible collector and was measured
596 from 200 nm to 2000 nm, with a spectral resolution of 1 nm. The absorption was determined
597 by %Absorption=100%-R-%T. The thickness of the printed films was measured using a
598 Mitutoyo Digimatic Indicator.

599

600 *Device Fabrication:* Screen-printing were performed using a manual M-Print® machine. The
601 three device parts were printed using three different mesh openings: 55 μm for the electrical
602 contacts, 149 μm for the light collector, and 249 μm for the TE stripes. Firstly, the TE printed
603 patterns were dried at 130 °C for 10 min. Then, the electrical contacts were printed over the TE
604 stripes, and then dried at 150 °C for 10 min. Finally, a circular collector pattern was printed
605 with the commercial carbon-based ink, and dried at 130 °C during 10 min. The final TE stripes
606 presented a length of 7 mm and a width of 2.5 mm. The electrical contacts presented a width of
607 1 mm. The circular light collector presented a diameter of 7 mm.

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Prototype Testing: The performance of the devices was measured using commercial gold connectors with copper cables in a closed system inside a cryostat, at $P \sim 10^{-6}$ Torr achieved by using a diffusion pump connected with a primary pump **Figure 13b**. The different temperatures (77 – 400 K) inside the cryostat were applied using liquid nitrogen (N_2) in the cooling structure of the system (second separate chamber), not being in contact with the device. A fiber laser with a wavelength of 1450 nm was used to generate different temperature gradients through different applied powers (0.5 – 2 W), with a spot of ~ 7 mm. The temperature control and measurement were performed using k-type thermocouples connected to a Lakeshore 336 Temperature Controller. The developed set-up can be seen in **Figure 13**.



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Figure 13 Developed set-up for the performance characterization of the fabricated prototype. (a) Schematic image of the concept of the set-up. (b) Image of the used cryostat and optical system.

In addition to the open-circuit output voltage measurement measured directly with nanovoltmeter, the device characterization was performed under a range of load resistances between 50Ω and $1 G\Omega$ with a fixed probe load ($R = 50 \Omega$). Two different configurations were used for this end, *i.e.*, open and closed circuit, for voltage and current measurements, respectively. The voltage value was directly obtained, the current value was established by Ohm's law ($I = V/R$) with the probe load, and the power output was given by $P = VI$.

634 **Supporting Information**

635 Supporting Information is available from the Wiley Online Library or from the author.

636

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644

645 **Conflict of Interest**

646 The authors declare no conflict of interest.

647

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653 **References**

- 654 [1] M. Song, P. Jayathurathnage, E. Zanganeh, M. Krasikova, P. Smirnov, P. Belov, P.
655 Kapitanova, C. Simovski, S. Tretyakov, A. Krasnok, *Nat Electron* **2021**, *4*, 707.
- 656 [2] A. Ahmed, Z. Saadatnia, I. Hassan, Y. Zi, Y. Xi, X. He, J. Zu, Z. L. Wang, *Adv. Energy*
657 *Mater.* **2017**, *7*, 1601705.
- 658 [3] K. Zhang, B. Ouyang, Y. Wang, Y. Xia, Y. Yang, *ACS Appl. Energy Mater.* **2019**, *2*,
659 7647.
- 660 [4] Y. Liu, X. Lan, J. Xu, W. Zhou, C. Liu, C. Liu, P. Liu, M. Li, F. Jiang, *ACS Appl. Mater.*
661 *Interfaces* **2021**, *13*, 43155.
- 662 [5] D.-L. Wen, X. Liu, J.-F. Bao, G.-K. Li, T. Feng, F. Zhang, D. Liu, X.-S. Zhang, *ACS*
663 *Appl. Mater. Interfaces* **2021**, *13*, 21401.
- 664 [6] Y. S. Jung, D. H. Jeong, S. B. Kang, F. Kim, M. H. Jeong, K.-S. Lee, J. S. Son, J. M.
665 Baik, J.-S. Kim, K. J. Choi, *Nano Energy* **2017**, *40*, 663.
- 666 [7] W. Zhu, Y. Deng, M. Gao, Y. Wang, *Energy Conversion and Management* **2015**, *106*,
667 1192.
- 668 [8] Z. Guo, W. Zhu, Y. Yu, Y. Deng, *IEEE Electron Device Lett.* **2019**, *40*, 1832.
- 669 [9] M. He, Y.-J. Lin, C.-M. Chiu, W. Yang, B. Zhang, D. Yun, Y. Xie, Z.-H. Lin, *Nano*
670 *Energy* **2018**, *49*, 588.
- 671 [10] C. Bianchi, A. C. Marques, R. C. da Silva, T. Calmeiro, I. Ferreira, *Sci Rep* **2021**, *11*,
672 24313.
- 673 [11] W. Kubo, M. Kondo, K. Miwa, *J. Phys. Chem. C* **2019**, *123*, 21670.
- 674 [12] X. Jin, H. Li, Y. Wang, Z. Yang, X. Qi, J. Yang, Y. Wang, *ACS Appl. Mater. Interfaces*
675 **2022**, *14*, 27083.
- 676 [13] N. Sharma, J. Bar-David, N. Mazurski, U. Levy, *ACS Photonics* **2020**, *7*, 2468.

- 677 [14] J. Bai, Z. Pang, P. Shen, T. Chen, W. Shen, S. Wang, S. Chang, *Optics Communications*
678 **2021**, 497, 127184.
- 679 [15] P. Cheng, H. Wang, B. Müller, J. Müller, D. Wang, P. Schaaf, *ACS Appl. Mater.*
680 *Interfaces* **2021**, 13, 1818.
- 681 [16] W. Zhu, Y. Deng, L. Cao, *Nano Energy* **2017**, 34, 463.
- 682 [17] S. Kim, Y. Na, C. Nam, C. K. Jeong, K. T. Kim, K.-I. Park, *Nano Energy* **2022**, 103,
683 107824.
- 684 [18] C. Kim, M.-W. Jeong, S. Kim, S.-H. Oh, S.-Y. Lee, Y.-C. Joo, H. Shen, H. Lee, J. Yoon,
685 Y. Joo, In *2020 IEEE 70th Electronic Components and Technology Conference (ECTC)*,
686 IEEE, Orlando, FL, USA, **2020**, pp. 2242–2246.
- 687 [19] Z. Yuan, X. Tang, Z. Xu, J. Li, W. Chen, K. Liu, Y. Liu, Z. Zhang, *Applied Energy* **2018**,
688 225, 746.
- 689 [20] B. Jabar, X. Qin, A. Mansoor, H. Ming, L. Huang, M. H. Danish, J. Zhang, D. Li, C. Zhu,
690 H. Xin, C. Song, *Nano Energy* **2021**, 80, 105512.
- 691 [21] K. Biswas, J. He, I. D. Blum, C.-I. Wu, T. P. Hogan, D. N. Seidman, V. P. Dravid, M. G.
692 Kanatzidis, *Nature* **2012**, 489, 414.
- 693 [22] W. Liu, D. Wang, Q. Liu, W. Zhou, Z. Shao, Z. Chen, *Adv. Energy Mater.* **2020**, 10,
694 2000367.
- 695 [23] G.-H. Kim, L. Shao, K. Zhang, K. P. Pipe, *Nature Materials* **2013**, 12, 719.
- 696 [24] N. Nandihalli, C.-J. Liu, T. Mori, *Nano Energy* **2020**, 78, 105186.
- 697 [25] Q. Zhang, Y. Sun, W. Xu, D. Zhu, *Adv. Mater.* **2014**, 26, 6829.
- 698 [26] J. Yang, H.-L. Yip, A. K.-Y. Jen, *Adv. Energy Mater.* **2013**, 3, 549.
- 699 [27] D. Park, J. Kim, *Journal of the Korean Institute of Electrical and Electronic Material*
700 *Engineers* **2022**, 35, 203.
- 701 [28] E. Jin Bae, Y. Hun Kang, K.-S. Jang, S. Yun Cho, *Sci Rep* **2016**, 6, 18805.
- 702 [29] T. Park, C. Park, B. Kim, H. Shin, E. Kim, *Energy Environ. Sci.* **2013**, 6, 788.
- 703 [30] Y. Xu, Y. Jia, P. Liu, Q. Jiang, D. Hu, Y. Ma, *Chemical Engineering Journal* **2021**, 404,
704 126552.
- 705 [31] Q. Yao, Q. Wang, L. Wang, L. Chen, *Energy Environ. Sci.* **2014**, 7, 3801.
- 706 [32] H. J. Lee, G. Anoop, H. J. Lee, C. Kim, J.-W. Park, J. Choi, H. Kim, Y.-J. Kim, E. Lee,
707 S.-G. Lee, Y.-M. Kim, J.-H. Lee, J. Y. Jo, *Energy Environ. Sci.* **2016**, 9, 2806.
- 708 [33] Y. Wang, J. Yang, L. Wang, K. Du, Q. Yin, Q. Yin, *ACS Appl. Mater. Interfaces* **2017**, 9,
709 20124.
- 710 [34] Z. Zhang, G. Chen, H. Wang, W. Zhai, *J. Mater. Chem. C* **2015**, 3, 1649.
- 711 [35] C. Dun, C. A. Hewitt, H. Huang, J. Xu, D. S. Montgomery, W. Nie, Q. Jiang, D. L.
712 Carroll, *ACS Appl. Mater. Interfaces* **2015**, 7, 7054.
- 713 [36] C. Dun, C. A. Hewitt, H. Huang, J. Xu, C. Zhou, W. Huang, Y. Cui, W. Zhou, Q. Jiang,
714 D. L. Carroll, *Nano Energy* **2015**, 18, 306.
- 715 [37] W. Hou, X. Nie, W. Zhao, H. Zhou, X. Mu, W. Zhu, Q. Zhang, *Nano Energy* **2018**, 50,
716 766.
- 717 [38] S. H. Kim, T. Min, J. W. Choi, S. H. Baek, J.-P. Choi, C. Aranas, *Energy* **2018**, 144, 607.
- 718 [39] Z. Antar, J. F. Feller, H. Noël, P. Glouannec, K. Elleuch, *Materials Letters* **2012**, 67, 210.
- 719 [40] J. Wang, H. Li, R. Liu, L. Li, Y.-H. Lin, C.-W. Nan, *Composites Science and Technology*
720 **2018**, 157, 1.
- 721 [41] Q. Meng, Y. Qiu, K. Cai, Y. Ding, M. Wang, H. Pu, Q. Yao, L. Chen, J. He, *ACS Appl.*
722 *Mater. Interfaces* **2019**, 11, 33254.
- 723 [42] C. Jiang, P. Wei, Y. Ding, K. Cai, L. Tong, Q. Gao, Y. Lu, W. Zhao, S. Chen, *Nano*
724 *Energy* **2021**, 80, 105488.
- 725 [43] A. G. El-Shamy, *Materials Science in Semiconductor Processing* **2019**, 100, 245.

- 726 [44] A. L. Pires, I. F. Cruz, J. Silva, G. N. P. Oliveira, S. Ferreira-Teixeira, A. M. L. Lopes, J.
727 P. Araújo, J. Fonseca, C. Pereira, A. M. Pereira, *ACS Applied Materials & Interfaces*
728 **2019**, *11*, 8969.
- 729 [45] T. Zhang, K. Li, C. Li, S. Ma, H. H. Hng, L. Wei, *Adv. Electron. Mater.* **2017**, *3*,
730 1600554.
- 731 [46] X. Li, K. Cai, M. Gao, Y. Du, S. Shen, *Nano Energy* **2021**, *89*, 106309.
- 732 [47] N. A. Bhatti, M. H. Alizai, A. A. Syed, L. Mottola, *ACM Transactions on Sensor*
733 *Networks* **2016**, *12*, 1.
- 734 [48] Z. Bi, T. Kan, C. C. Mi, Y. Zhang, Z. Zhao, G. A. Keoleian, *Applied Energy* **2016**, *179*,
735 413.
- 736 [49] S. Assawaworrarit, X. Yu, S. Fan, *Nature* **2017**, *546*, 387.
- 737 [50] C. Jiang, X. Li, S. W. M. Lian, Y. Ying, J. S. Ho, J. Ping, *ACS Nano* **2021**, *15*, 9328.
- 738 [51] T. D. Ponnimbaduge Perera, D. N. K. Jayakody, S. K. Sharma, S. Chatzinotas, J. Li,
739 *IEEE Communications Surveys & Tutorials* **2018**, *20*, 264.
- 740 [52] A. Sahai, D. Graham, In *2011 International Conference on Space Optical Systems and*
741 *Applications (ICSOS)*, IEEE, Santa Monica, CA, USA, **2011**, pp. 164–170.
- 742 [53] H. Suzuki, H. Yoshida, K. Kisara, T. Nakamura, M. Imaizumi, In *2014 IEEE 40th*
743 *Photovoltaic Specialist Conference (PVSC)*, IEEE, Denver, CO, USA, **2014**, pp. 1834–
744 1838.
- 745 [54] H. Chu, C. Wang, In *2020 International Conference on Optoelectronic Materials and*
746 *Devices* (Eds.: Chen, S.; Wang, P.), SPIE, Guangzhou, China, **2021**, p. 2.
- 747 [55] G. A. Landis, *IEEE Aerospace and Electronic Systems Magazine* **1991**, *6*, 3.
- 748 [56] X. Lu, L. Sun, P. Jiang, X. Bao, *Adv. Mater.* **2019**, *31*, 1902044.
- 749 [57] X. Zhang, T.-T. Li, H.-T. Ren, H.-K. Peng, B.-C. Shiu, Y. Wang, C.-W. Lou, J.-H. Lin,
750 *ACS Appl. Mater. Interfaces* **2020**, *12*, 55072.
- 751 [58] H. Park, D. Lee, G. Park, S. Park, S. Khan, J. Kim, W. Kim, *J. Phys. Energy* **2019**, *1*,
752 042001.
- 753 [59] H. Hemmati, A. Biswas, I. B. Djordjevic, *Proc. IEEE* **2011**, *99*, 2020.
- 754 [60] B. Jabar, A. Mansoor, Y. Chen, S. Jamil, S. Chen, G. Liang, F. Li, P. Fan, Z. Zheng,
755 *Chemical Engineering Journal* **2022**, *435*, 135062.
- 756 [61] Z. Starý, J. Horák, M. Stordeur, M. Stölzer, *Journal of Physics and Chemistry of Solids*
757 **1988**, *49*, 29.
- 758 [62] C. Chen, D.-W. Liu, B.-P. Zhang, J.-F. Li, *Journal of Elec Materi* **2011**, *40*, 942.
- 759 [63] J. Cardoso, O. GomezDaza, L. Ixtlilco, M. T. S. Nair, P. K. Nair, *Semicond. Sci. Technol.*
760 **2001**, *16*, 123.
- 761 [64] T. Fang, X. Li, C. Hu, Q. Zhang, J. Yang, W. Zhang, X. Zhao, D. J. Singh, T. Zhu, *Adv.*
762 *Funct. Mater.* **2019**, *29*, 1900677.
- 763 [65] O. Gh. Abdullah, S. B. Aziz, K. M. Omer, Y. M. Salih, *J Mater Sci: Mater Electron*
764 **2015**, *26*, 5303.
- 765 [66] Q. Li, Z. Wei, Q. Ma, Z. Li, J. Luo, *ACS Omega* **2021**, *6*, 33883.
- 766 [67] J. Li, A. B. Huckleby, M. Zhang, *Journal of Materiomics* **2022**, *8*, 204.
- 767 [68] S. Ferreira-Teixeira, F. Carpinteiro, J. P. Araújo, J. B. Sousa, A. M. Pereira, *Review of*
768 *Scientific Instruments* **2021**, *92*, 043904.
- 769 [69] E. Bilotti, O. Fenwick, B. C. Schroeder, M. Baxendale, P. Taroni-Junior, T. Degousée, Z.
770 Liu, In *Comprehensive Composite Materials II*, Elsevier, **2018**, pp. 408–430.
- 771 [70] Y. Ueki, T. Aoki, K. Ueda, M. Shibahara, *International Journal of Heat and Mass*
772 *Transfer* **2017**, *113*, 1130.
- 773 [71] G. Wypych, In *Databook of Antistatics*, Elsevier, **2014**, pp. 245–271.
- 774 [72] A. Montecucco, J. Siviter, A. R. Knox, *Applied Energy* **2015**, *149*, 248.
- 775 [73] O. Ben-Yehuda, R. Shuker, Y. Gelbstein, Z. Dashevsky, M. P. Dariel, *Journal of Applied*
776 *Physics* **2007**, *101*, 113707.

- 777 [74] Q. Fu, Y. Xiong, W. Zhang, D. Xu, *Rev. Sci. Instrum.* **2017**, *88*, 095111.
778 [75] R. Bjørk, D. V. Christensen, D. Eriksen, N. Pryds, *International Journal of Thermal*
779 *Sciences* **2014**, *85*, 12.
780 [76] B. Beltrán-Pitarch, J. García-Cañadas, *Vacuum* **2020**, *172*, 109088.
781 [77] A. Elhefnawy, A. Elmaihi, A. Elweteedy, *FME Transactions* **2021**, *49*, 1014.
782 [78] Park, Su-Jin, Lee, Eun-Jung, Kwon, Soo-Han, *Bulletin of the Korean Chemical Society*
783 **2007**, *28*, 188.
784
785